100 V, 3.0 A, Low V_{CE(sat)} **PNP Transistor**

ON Semiconductor's e²PowerEdge family of low V_{CE(sat)} transistors are miniature surface mount devices featuring ultra low saturation voltage (V_{CE(sat)}) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC-DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

• This is a Pb-Free Device

MAXIMUM RATINGS (T_A = 25°C)

Rating	Symbol	Мах	Unit
Collector-Emitter Voltage	V _{CEO}	-100	Vdc
Collector-Base Voltage	V _{CBO}	-140	Vdc
Emitter-Base Voltage	V _{EBO}	-7.0	Vdc
Collector Current – Continuous	۱ _C	-2.0	А
Collector Current - Peak	I _{CM}	-3.0	А

THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	P _D (Note 1)	490 3.7	mW mW/°C
Derate above 25 C		3.7	IIIVV/ C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$ (Note 1)	255	°C/W
Total Device Dissipation $T_{A} = 25^{\circ}C$	P _D (Note 2)	710	mW
Derate above 25°C		4.3	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$ (Note 2)	176	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

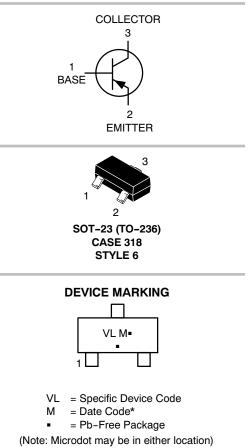
FR-4 @ 100 mm², 1 oz. copper traces.
FR-4 @ 500 mm², 1 oz. copper traces.



ON Semiconductor[®]

http://onsemi.com

-100 VOLTS, 3.0 AMPS PNP LOW V_{CE(sat)} TRANSISTOR



*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
NSS1C200LT1G	SOT-23 (Pb-Free)	3000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

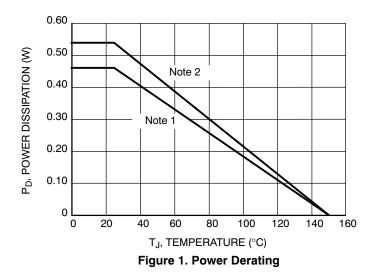
ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

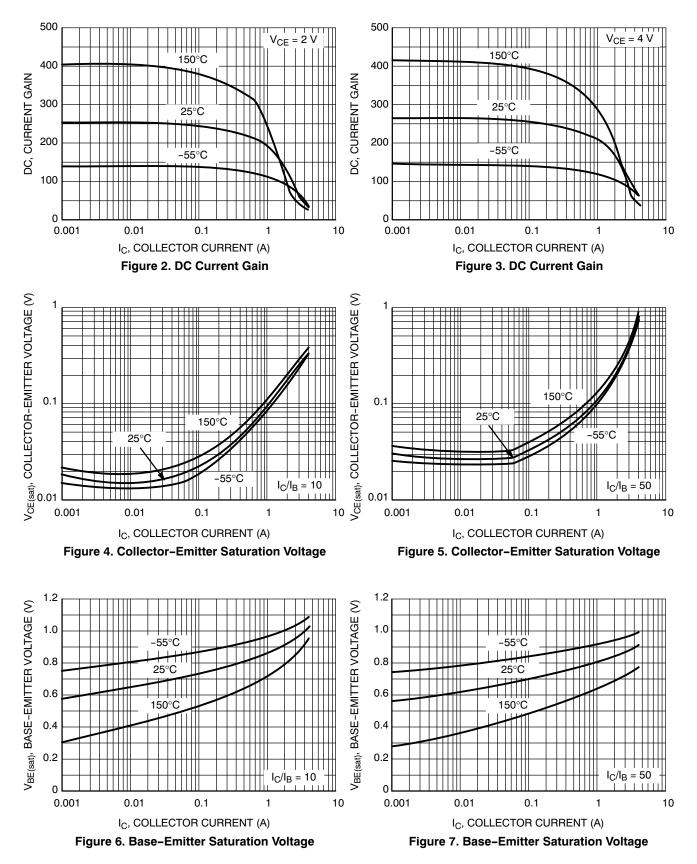
Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage $(I_{C} = -10 \text{ mAdc}, I_{B} = 0)$	V _{(BR)CEO}	-100			Vdc
Collector – Base Breakdown Voltage $(I_{C} = -0.1 \text{ mAdc}, I_{E} = 0)$	V _{(BR)CBO}	-140			Vdc
Emitter – Base Breakdown Voltage $(I_E = -0.1 \text{ mAdc}, I_C = 0)$	V _{(BR)EBO}	-7.0			Vdc
Collector Cutoff Current ($V_{CB} = -140 \text{ Vdc}, I_E = 0$)	I _{CBO}			-100	nAdc
Emitter Cutoff Current (V _{EB} = -6.0 Vdc)	I _{EBO}			-50	nAdc

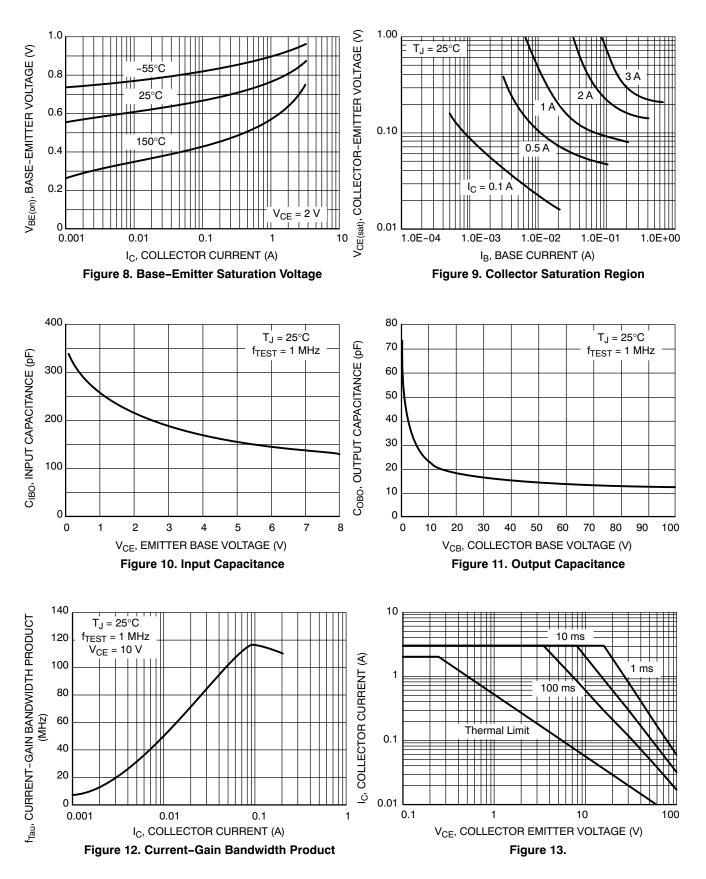
ON CHARACTERISTICS

DC Current Gain (Note 3) ($I_C = -10 \text{ mA}, V_{CE} = -2.0 \text{ V}$) ($I_C = -500 \text{ mA}, V_{CE} = -2.0 \text{ V}$) ($I_C = -1.0 \text{ A}, V_{CE} = -2.0 \text{ V}$) ($I_C = -2.0 \text{ A}, V_{CE} = -2.0 \text{ V}$)	h _{FE}	150 120 80 50	240	360	
Collector - Emitter Saturation Voltage (Note 3) ($I_C = -0.1 \text{ A}, I_B = -0.01 \text{ A}$) ($I_C = -0.5 \text{ A}, I_B = -0.05 \text{ A}$) ($I_C = -1.0 \text{ A}, I_B = -0.100 \text{ A}$) ($I_C = -2.0 \text{ A}, I_B = -0.200 \text{ A}$)	V _{CE(sat)}			-0.040 -0.080 -0.115 -0.250	V
Base – Emitter Saturation Voltage (Note 3) ($I_C = -1.0 \text{ A}, I_B = -0.100 \text{ A}$)	V _{BE(sat)}			-0.950	V
Base – Emitter Turn-on Voltage (Note 3) ($I_c = -1.0 \text{ A}, V_{CE} = -2.0 \text{ V}$)	V _{BE(on)}			-0.850	V
Cutoff Frequency ($I_C = -100 \text{ mA}, V_{CE} = -5.0 \text{ V}, f = 100 \text{ MHz}$)	f _T		120		MHz
Input Capacitance (V _{EB} = 2.0 V, f = 1.0 MHz)	Cibo		200		pF
Output Capacitance (V _{CB} = 10 V, f = 1.0 MHz)	Cobo		22		pF

3. Pulsed Condition: Pulse Width = 300 msec, Duty Cycle \leq 2%.







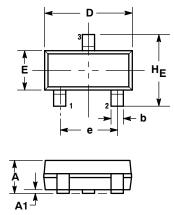
PACKAGE DIMENSIONS

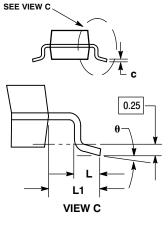
SOT-23 (TO-236) CASE 318-08 **ISSUE AN**

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH
- 2
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD з. THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL. 318-01 THRU -07 AND -09 OBSOLETE, NEW
- STANDARD 318-08

	м	ILLIMETE	RS		INCHES	
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104



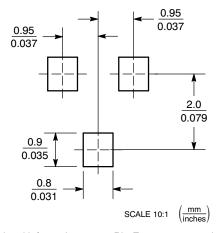


STYLE 6: BASE PIN 1.

EMITTER 2 3.

COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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